

# **Excellent Integrated System Limited**

Stocking Distributor

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ON Semiconductor SBRA8160T3G

For any questions, you can email us directly: <u>sales@integrated-circuit.com</u>



**Distributor of ON Semiconductor: Excellent Integrated System Limited** Datasheet of SBRA8160T3G - DIODE SCHOTTKY 60V 1A SMA Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

## SS16T3G, SBRA8160T3G

## Surface Mount Schottky Power Rectifier

## SMA Power Surface Mount Package

These devices employ the Schottky Barrier principle in a large area metal-to-silicon power diode. State of the art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity diodes in surface mount applications where compact size and weight are critical to the system.

## Features

- Small Compact Surface Mountable Package with J-Bent Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Guardring for Stress Protection
- AEC-Q101 Qualified and PPAP Capable
- SBRA8 Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- All Packages are Pb-Free\*

#### **Mechanical Characteristics**

- Case: Epoxy, Molded, Epoxy Meets UL 94 V-0
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm tape, 5000 units per 13 inch reel
- Polarity: Cathode Lead Indicated by Polarity Band
- ESD Ratings:
  - ♦ Machine Model = C
  - ◆ Human Body Model = 3B
- Device Meets MSL 1 Requirements



## **ON Semiconductor**<sup>®</sup>

http://onsemi.com

## SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 60 VOLTS



SMA CASE 403D PLASTIC

#### **MARKING DIAGRAM**



SS16	= Specific Device Code
А	= Assembly Location

= Year

- WW = Work Week
  - = Pb-Free Package

## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>	
SS16T3G	SMA (Pb–Free)	5,000 / Tape & Reel	
SBRA8160T3G	SMA (Pb–Free)	5,000 / Tape & Reel	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



## SS16T3G, SBRA8160T3G

## MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C = 105^{\circ}C$ )	Ι <sub>Ο</sub>	1.0	А
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Storage/Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +150	°C
Voltage Rate of Change (Rated $V_R$ , $T_J = 25^{\circ}C$ )	dv/dt	10,000	V/µs

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

## THERMAL CHARACTERISTICS

Characteristic		Value	Unit
Thermal Resistance, Junction-to-Lead (Note 1) Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{ heta JL} \ R_{ heta JA}$	35 86	°C/W

1. Mounted on 2 in Square PC Board with 1 in Square Total Pad Size, PC Board FR4.

## **ELECTRICAL CHARACTERISTICS**

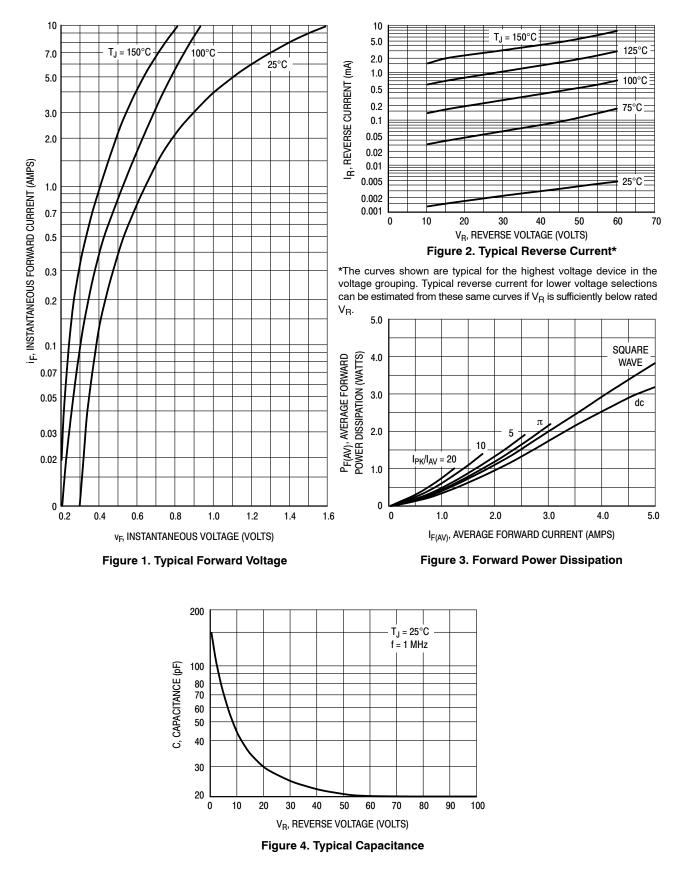
Characteristic	Symbol	Value		Unit
Maximum Instantaneous Forward Voltage (Note 2)	V <sub>F</sub>	T <sub>J</sub> = 25°C		V
$(I_F = 0.1 \text{ A})$ $(I_F = 1.0 \text{ A})$		0.9 0.7		
Maximum Instantaneous Reverse Current	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	mA
$(V_{\rm R} = 60 \text{ V})$		0.2	5.0	

2. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2.0%.



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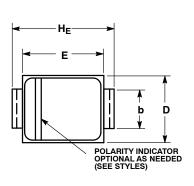
## SS16T3G, SBRA8160T3G





## SS16T3G, SBRA8160T3G

## PACKAGE DIMENSIONS

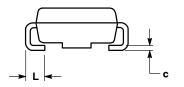


SMA CASE 403D-02 **ISSUE F** 

NOTES:

DIBENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
CONTROLLING DIMENSION: INCH.
403D-01 OBSOLETE, NEW STANDARD IS 403D-02.

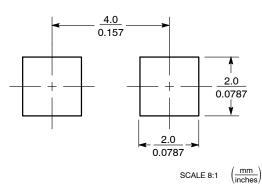
	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	1.97	2.10	2.20	0.078	0.083	0.087	
A1	0.05	0.10	0.15	0.002	0.004	0.006	
b	1.27	1.45	1.63	0.050	0.057	0.064	
С	0.15	0.28	0.41	0.006	0.011	0.016	
D	2.29	2.60	2.92	0.090	0.103	0.115	
Е	4.06	4.32	4.57	0.160	0.170	0.180	
HE	4.83	5.21	5.59	0.190	0.205	0.220	
L	0.76	1.14	1.52	0.030	0.045	0.060	





STYLE 1: PIN 1. CATHODE (POLARITY BAND) 2. ANODE

**SOLDERING FOOTPRINT\*** 



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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